

## SGC0910-300B-R

X-band Internally Matched GaN-HEMT

#### Features

- High Output Power: P<sub>sat</sub>=55.3dBm (Typ.)
- High Gain: G<sub>p</sub>=9.3dB (Typ.)
- High Power Added Efficiency: PAE=38% (Typ.)
- Broad Band: 9.0 to 10.0GHz
- Impedance Matched Zin/Zout = 50ohm
- Hermetically Sealed Package
- Long pulse operation \*

\*Reduced Vds and/or low case temperature are needed to keep Tch below 200 deg.C. Please contact for the detail.

Description

The SGC0910-300B-R is a high power GaN-HEMT that is internally matched for X-band radar bands to provide optimum power and gain in a 500hm system.

#### ABSOLUTE MAXIMUM RATING (Case Temperature T<sub>c</sub>=25 deg.C)

Item	Symbol	Rating	Unit
Drain-Source Voltage	V <sub>DS</sub>	55	V
Gate-Source Voltage	V <sub>GS</sub>	-15	V
Storage Temperature	T <sub>sta</sub>	-55 to +125	deg.C
Channel Temperature	T <sub>ch</sub>	+250	deg.C

#### **RECOMMENDED OPERATING CONDITION**

Item	Symbol	Condition	Limit	Unit
Drain-Source Voltage	V <sub>DS</sub>		<=50	V
Forward Gate Current	I <sub>GF</sub>	Rg=10ohm	<=187.2	mA
Reverse Gate Current	I <sub>GR</sub>	Rg=10ohm	>=-13.6	mA
Channel Temperature	T <sub>ch</sub>		<+200	deg.C
Output Power	Pout		<=P5dB	dBm

#### **ELECTRICAL CHARACTERISTICS (Case Temperature T<sub>c</sub>=25 deg.C)**

Item	Symbol	Condition	Limit			Unit
Item	Symbol		Min.	Тур.	Max.	Unit
Pinch-off Voltage	VP	V <sub>DS</sub> =50V, I <sub>DS</sub> =20.0mA	-	-4.5	-	V
Frequency Range	Freq.	$V_{DS}=50V$	9.0	-	10.0	GHz
Output Power *1	P <sub>sat</sub>	$I_{DS(DC)}=1.0A$	54.3	55.3	-	dBm
Output Power *2	$P_{sat}$	Pulse Width=100µsec.	53.7	54.7	-	dBm
Power Gain *1	G <sub>P</sub>	Duty=10%	8.3	9.3	-	dB
Power Gain *2	G <sub>P</sub>	*1:f=9.0 to 9.6GHz	7.7	8.7	-	dB
Drain Current	I <sub>DSR</sub>	*2:f=9.6 to 10.0GHz	-	15.8	18.4	A
Power Added Efficiency	PAE	Pin=46dBm	-	38	-	%
Thermal Resistance	R <sub>th</sub>	Channel to Case (P <sub>diss</sub> =100W, CW)	-	0.7	0.8	deg.C/W

CASE STYLE	IK	
RoHS Compliance	YES	
ESD	Class 2	2000V to <4000V

Note: Based on ANSI/ESDA/JEDEC JS-001-2012(C=100pF, R=1.5kohm)



Edition 2.0

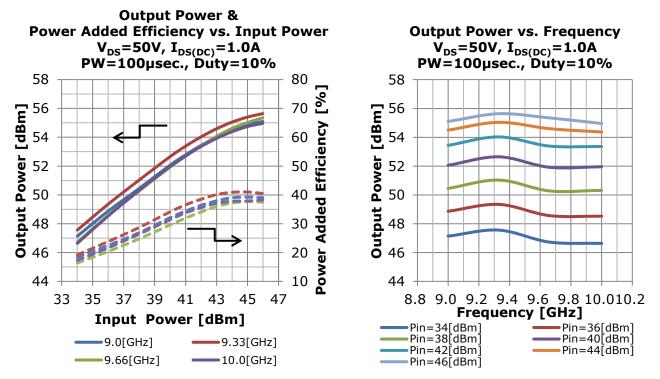
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### **SGC0910-300B-R** X-band Internally Matched GaN-HEMT

#### • **RF** Characteristics



• Thermal Characteristics In Pulsed Operation



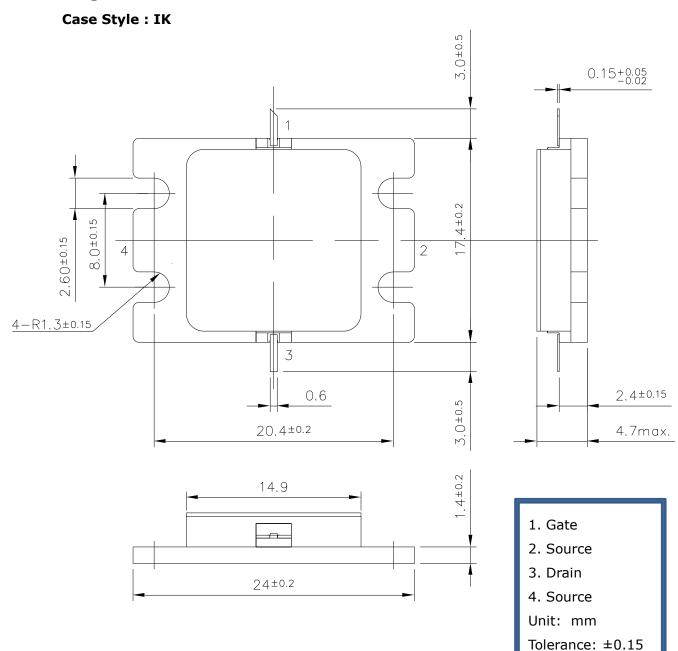
#### Rth vs. Pulse Width



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• Package Outline





#### For Safety, Observe the Following Procedures Environmental Management

- Do not put this product into the mouth.
- Do not alter the form of this product into a gas, powder, or liquid through burning, crushing, or chemical processing as these by-products are dangerous to the human body if inhaled, ingested, or swallowed.
- Respect all applicable laws of the country when discarding this product. This product must be disposed in accordance with methods specified by applicable hazardous waste procedures.

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